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NOTICE OF REFERENCES CITED		APPLICANT(S) <u>Bergman</u>		

## U.S. PATENT DOCUMENTS

*	DOCUMENT NO.	DATE	NAME	CLASS	SUB-CLASS	FILING DATE IF APPROPRIATE
A	H 34 2 08 2	7-27-82	Brown et al.	364	200	
B	H 6 4 1 2 7 5	2-3-87	Hatakeyama et al.	364	900	
C	H 4 5 4 5 7 8 6	12-84	Matsumoto et al.	364	200	
D	H 3 9 5 7 5 8 7	26-83	Helenius et al.	364	200	
E	H 3 8 4 3 2 4 5	17-83	Kim et al.	364	200	
F	H 3 3 2 0 0 8 5	25-82	Shima et al.	364	200	
G	H 1 3 6 3 8 3	1-23-79	Takesue	364	200	
H	H 3 9 1 6 3 8 3	10-28-75	Malcolm	364	200	
I	H 7 0 5 3 4 4	11-10-87	Hinton et al.	350	3. 73	
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## FOREIGN PATENT DOCUMENTS

*	DOCUMENT NO.	DATE	COUNTRY	NAME	CLASS	SUB-CLASS	PERTINENT SHPTS. IN SPEC.
L							
M							
N							
O							
P							
Q							

## OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)

R	Wu, W.H. et al., "Implementation of Optical Interconnections for VLSI", <u>IEEE Transactions on Electron Devices</u> , Vol. ED-34, No. 3, March 1987, pp. 706 - 706. 714
S	Bergman, L.A. et al. "Holographic Optical Interconnects For VLSI", <u>Optical Engineering</u> , Vol. 25, No. 10, October 1986, pp. 1109 - 1118.
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EXAMINER	<u>John C. K.</u>	DATE	<u>5-9-89</u>
* A copy of this reference is not being furnished with this office action. (See Manual of Patent Examining Procedure, section 707.05 (a).)			